

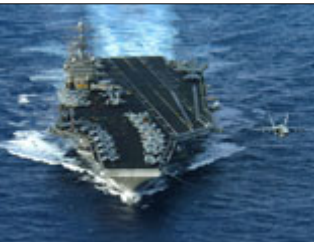
# DSU-33C/B Proximity Sensor Design to Production Transition

*Thursday, May 24, 2007*

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*51st Annual  
NDIA Fuze Conference  
Nashville, TN*

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**“I know the price of success: dedication, hard work, and an unremitting devotion to the things you want to see happen.”**

**Frank Lloyd Wright**

## DSU-33/B Product Description

## DSU-33/B History

## DSU-33C/B Manufacturability Workshop

- Team Members
- Goals/Result
- Lean Activity

## Questions?



# DSU-33C/B: Product Description



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- Provide air burst proximity fuzing for general-purpose bombs and warheads, including M117 and MK80 series (also JDAM)
- Provide fire pulse signal to the FMU-139, FMU-152 electronic fuzes
- Weighs under 2.3 Kg (5 lb)
- Self powered by internal thermal battery after receipt of initiation signal
- Initiation signal provided by
  - FZU-48/FZU-55 (U.S. Air Force Aircraft)
  - Fuze Functional Control Set (FFCS) for U.S. Navy Aircraft
- 95% Reliability over 10 year storage life
  - HOB of 5 ft to 35 ft at 80%, 0 ft to 50 ft at 100%
  - All surfaces condition including water



# DSU-33 History



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1980's Motorola developed DSU-33A/B

1990-1995 Motorola produced DSU-33A/B for U.S. Air Force

1998 DSU-33B/B JDAM design upgrade is completed.

2000-2005 ATK produced DSU-33B/B for U.S. Air Force.

2003 ATK starts development of DSU-33C/B

2005 ATK completed qualification DSU-33C/B

2005- Present ATK in production DSU-33C/B



***DSU-33: Supporting Freedom!***

## Design For Manufacturability Workshop – Focused on Production

US Government Participation

ATK Design Engineering

RF

Electrical

Mechanical

Production Engineer

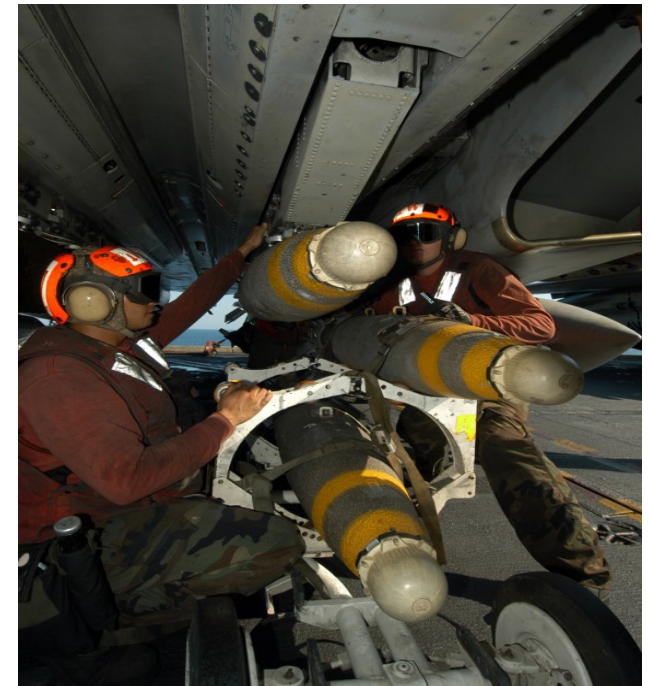
Quality Engineer

Production Supervisor

Surface Mount CCA Engineer

Test Engineer

Production Lead Operator



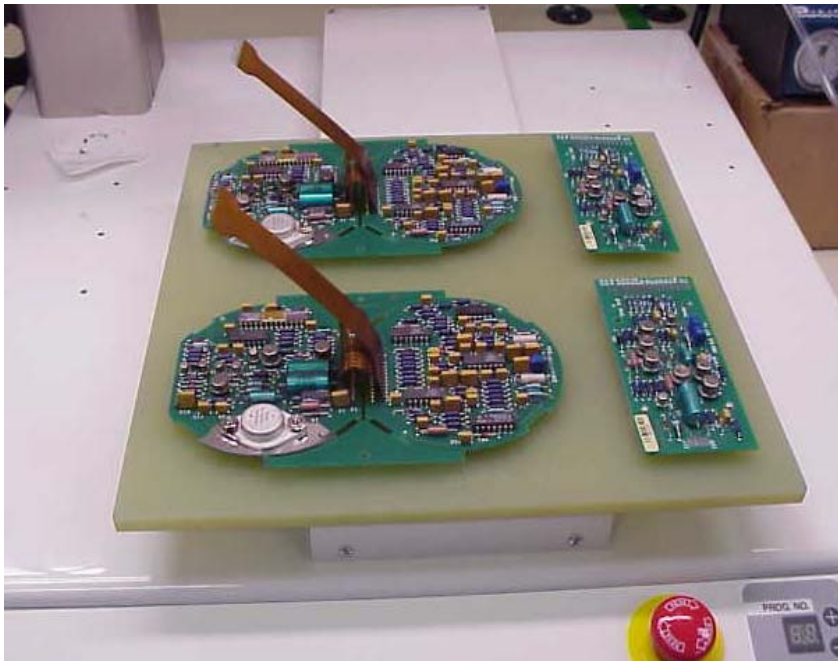
Eliminated epoxy staking of components on Circuit Card Assemblies

Through Hole to Surface Mount Technology (SMT)

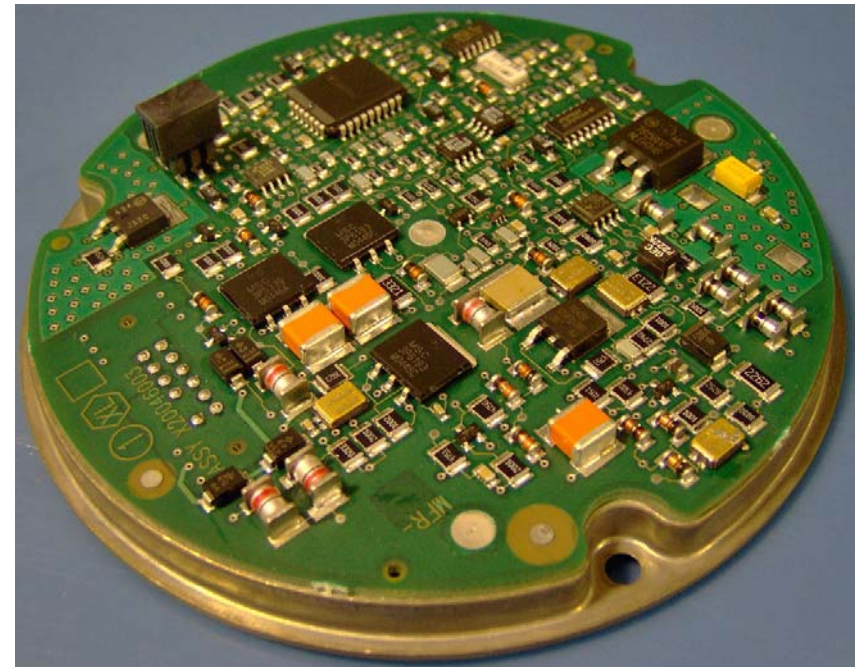
Brought SMT CCA Process in House

More Control / Lower Cost

B/B X-Y Table Application of Epoxy Required



C/B No Epoxy Required



# DSU-33C/B Goals/Results



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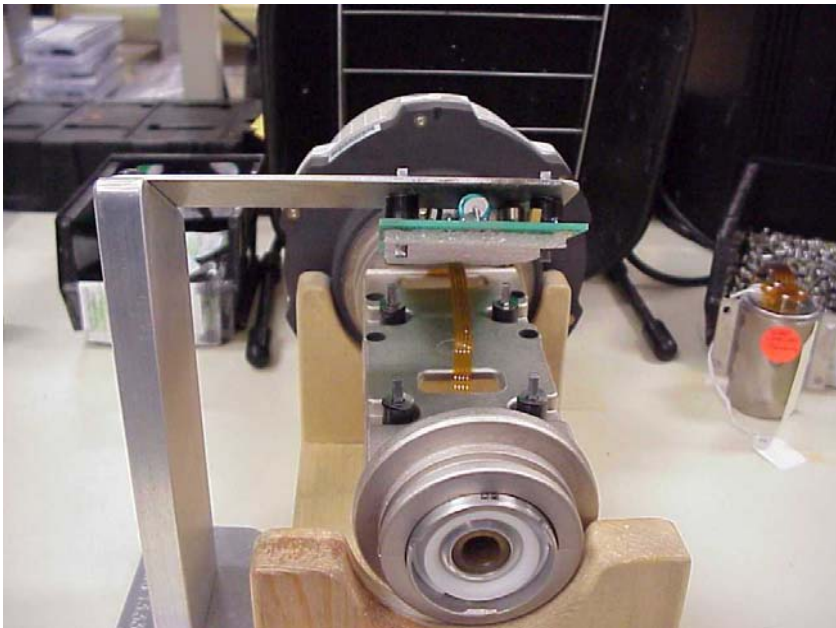
Eliminated embedded re-processing in build cycle

DSU-33B/B build process required:

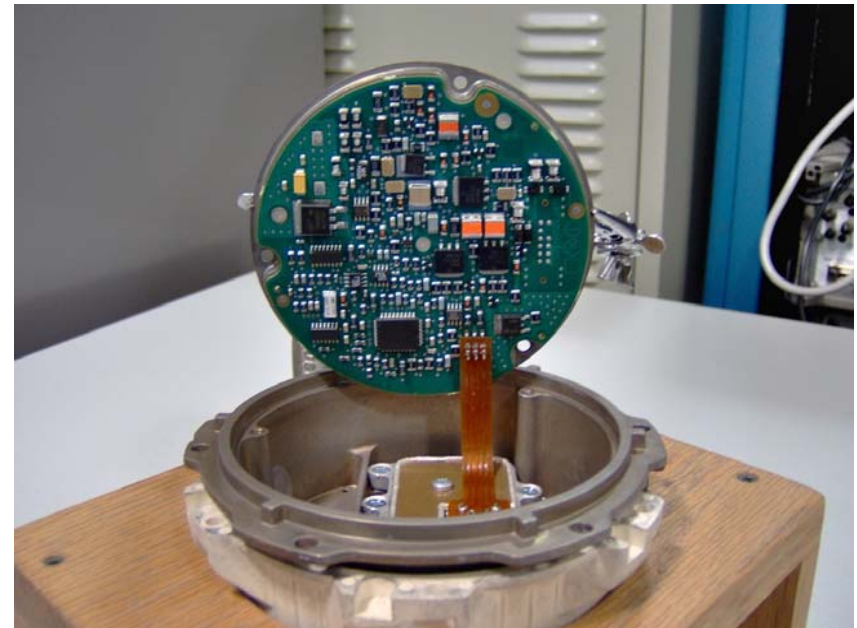
Assemble, test, disassemble prior to installing thermal battery

DSU-33C/B process flow has no disassembly required.

Disassembly Required



No Disassembly Required



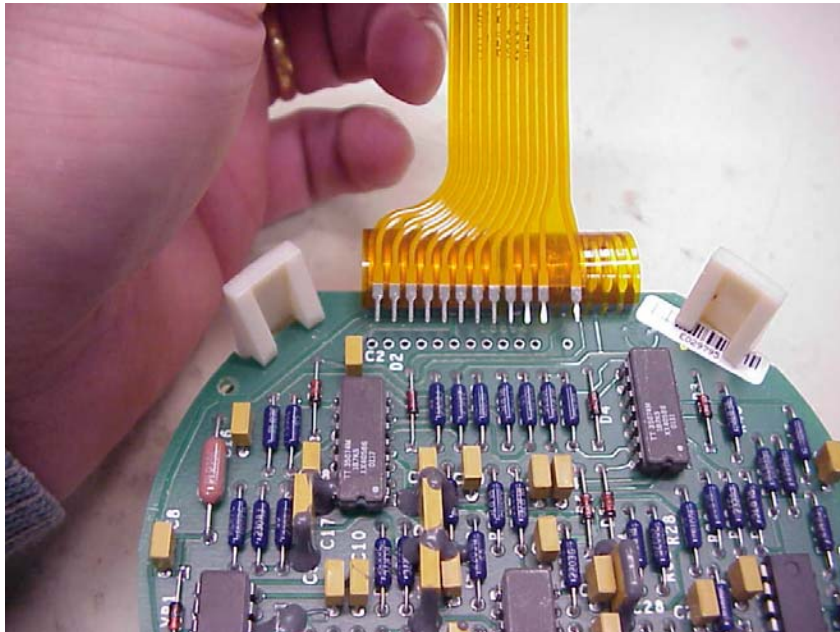


Eliminate hand soldered joints

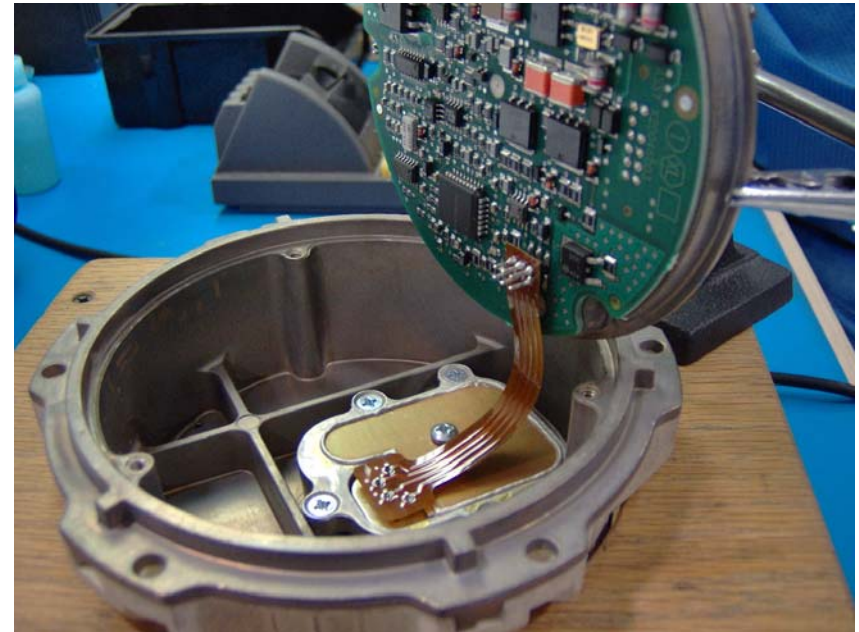
Eliminated two (2) flex cables and associated solder joints

Reduced hand soldering by 21%

B/B Flex Cables



C/B Flex Cables



Reduction of Process Steps by 24%

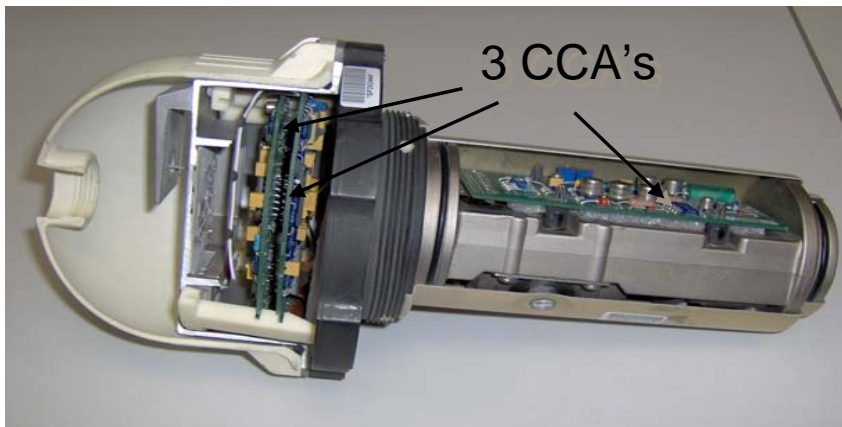
Eliminated laser welding operations

Eliminated mixed technology RF Assembly

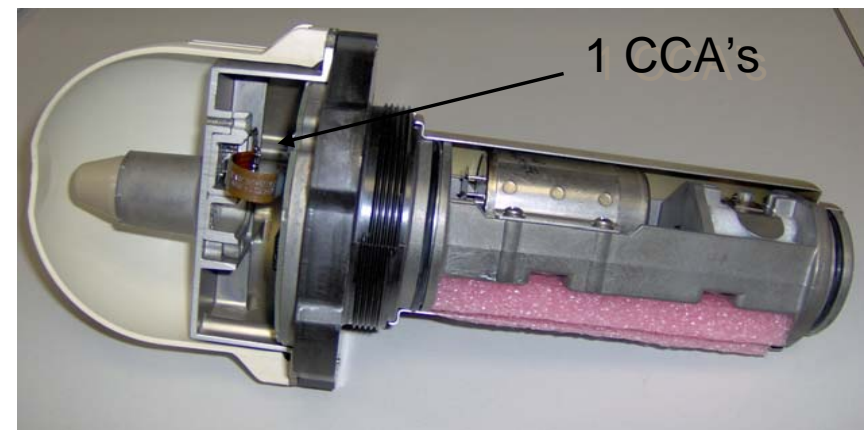
Reduced hand soldering operations by 21%

# Test operations reduced by 25%

DSU-33B/B Cut Away



DSU-33C/B Cut Away

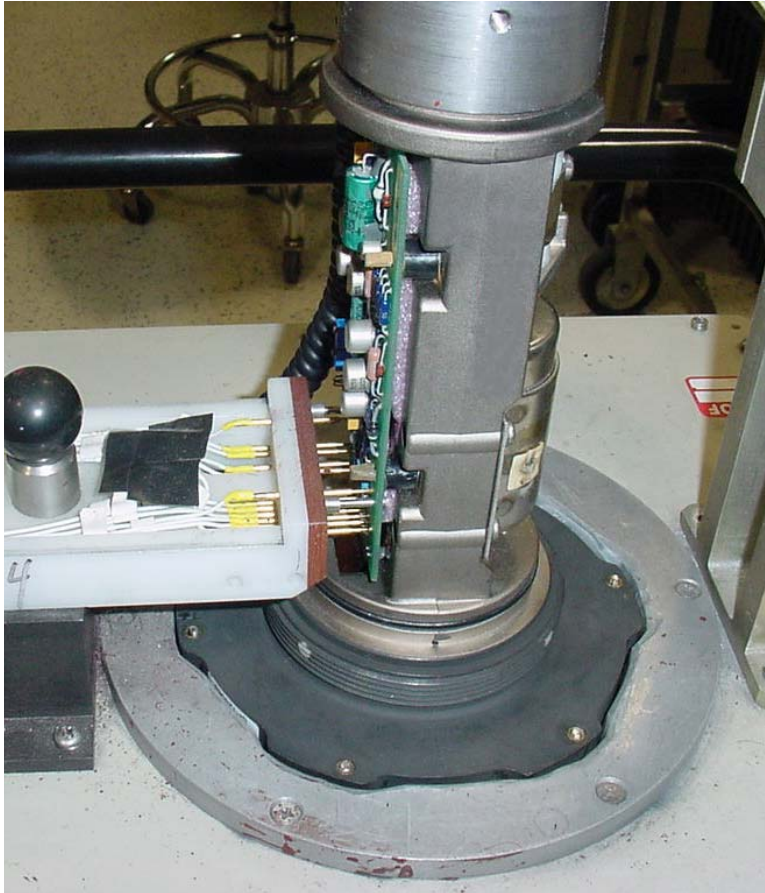


# DSU-33C/B Designed for Testability

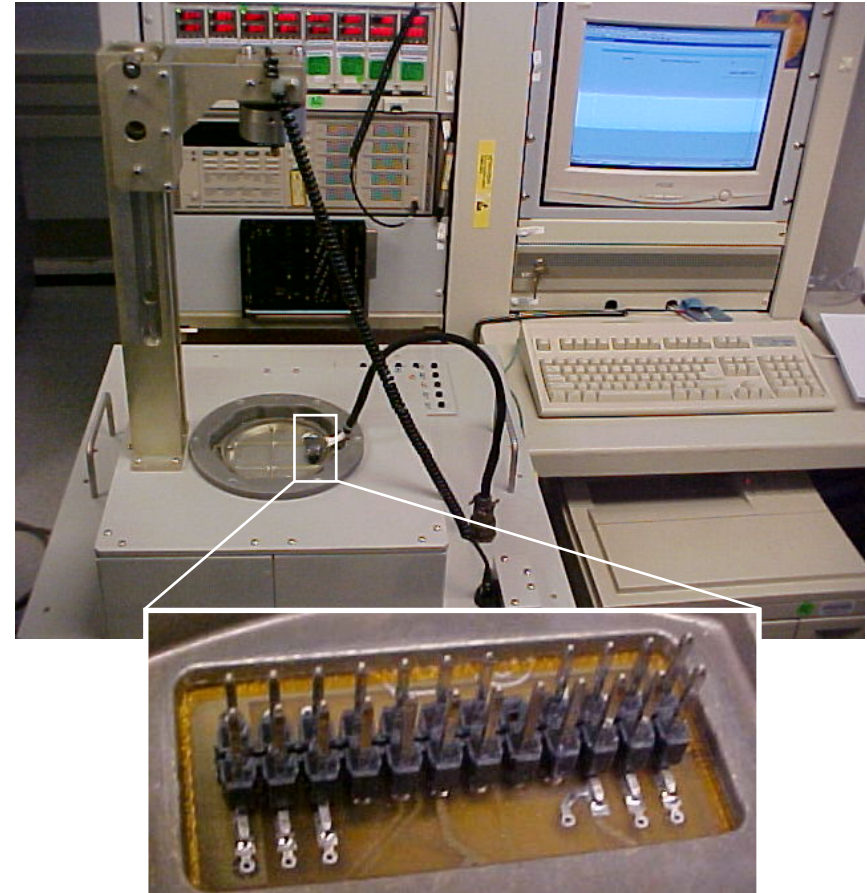


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B/B Test Interface



C/B Test Interface



DSU-33C/B Test Interface is More Reliable and User Friendly.

# DSU-33 System Test Yields Comparisons



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Every DSU-33 Sensor is functionally tested at an ambient, cold and hot condition.

	First Pass Yields	
	DSU-33 B/B	DSU-33-C/B
	2004-2005	2005-2007
Sensor Ambient	96.90%	95.30%
Sensor Cold	69.30%	93.30%
Sensor Hot	82.40%	94.60%
Rolled Yield	55.33%	84.11%

**Increase Rolled Yield by 29%**

# DSU-33C/B Producibility



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Decreased Touch Hours by 30%

Improved rolled test yields by 29%

Reduced process steps by 24%

Reduced hand solder joints by 21%

Increased capacity of factory by 34%



## Team Members

Production Supervisor

Production Engineer

Quality Engineer

Production Control

Production Lead Operator

## Goals

Increases Quality – Real time issues surface faster

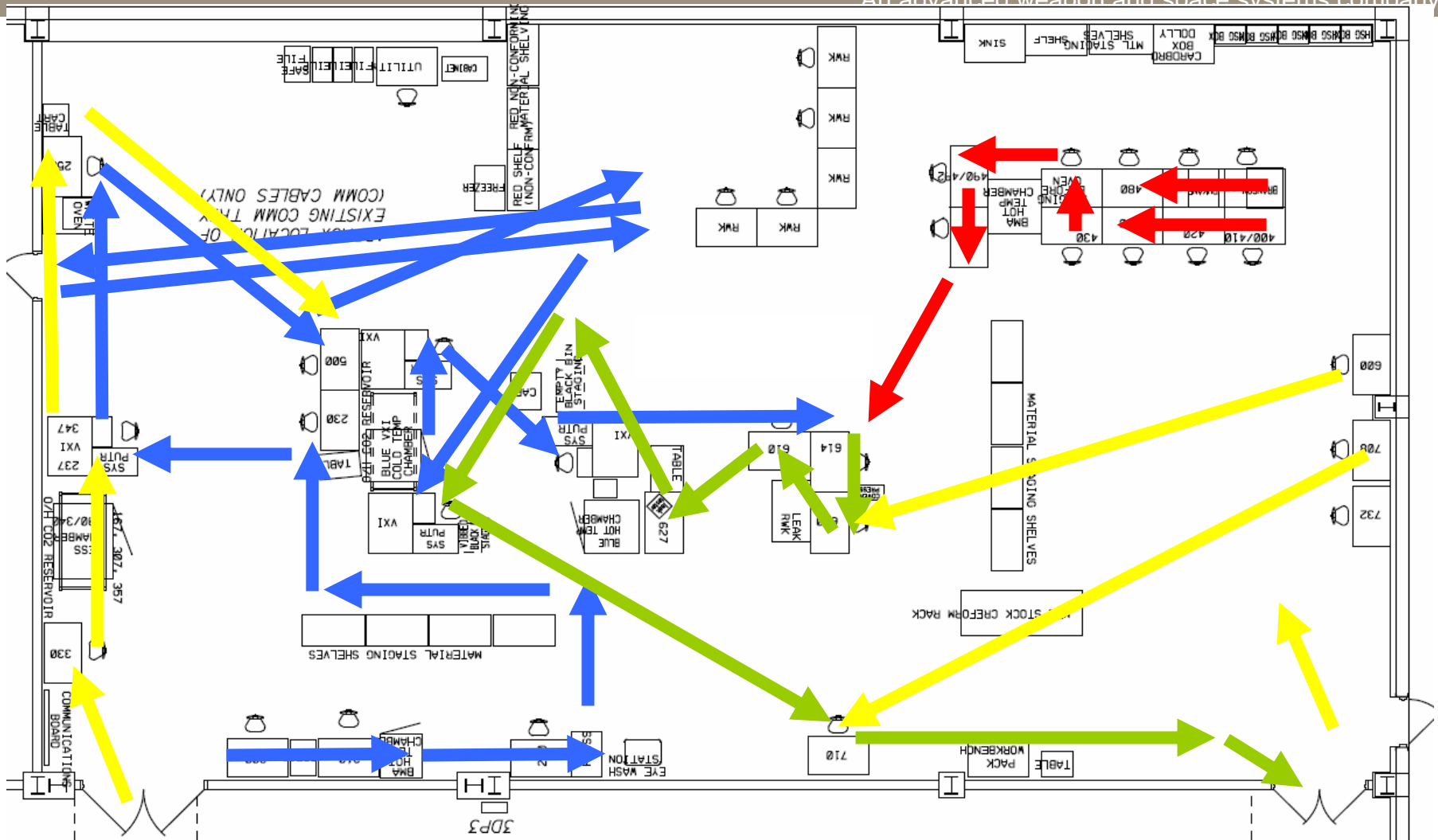
Reduced Risk – Manufacturing problems are found earlier

Reduced Cost – Eliminate unnecessary steps and labor

# DSU 'Lean' – Current State



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 **SENSOR TAIL**

 **SENSOR HEAD**

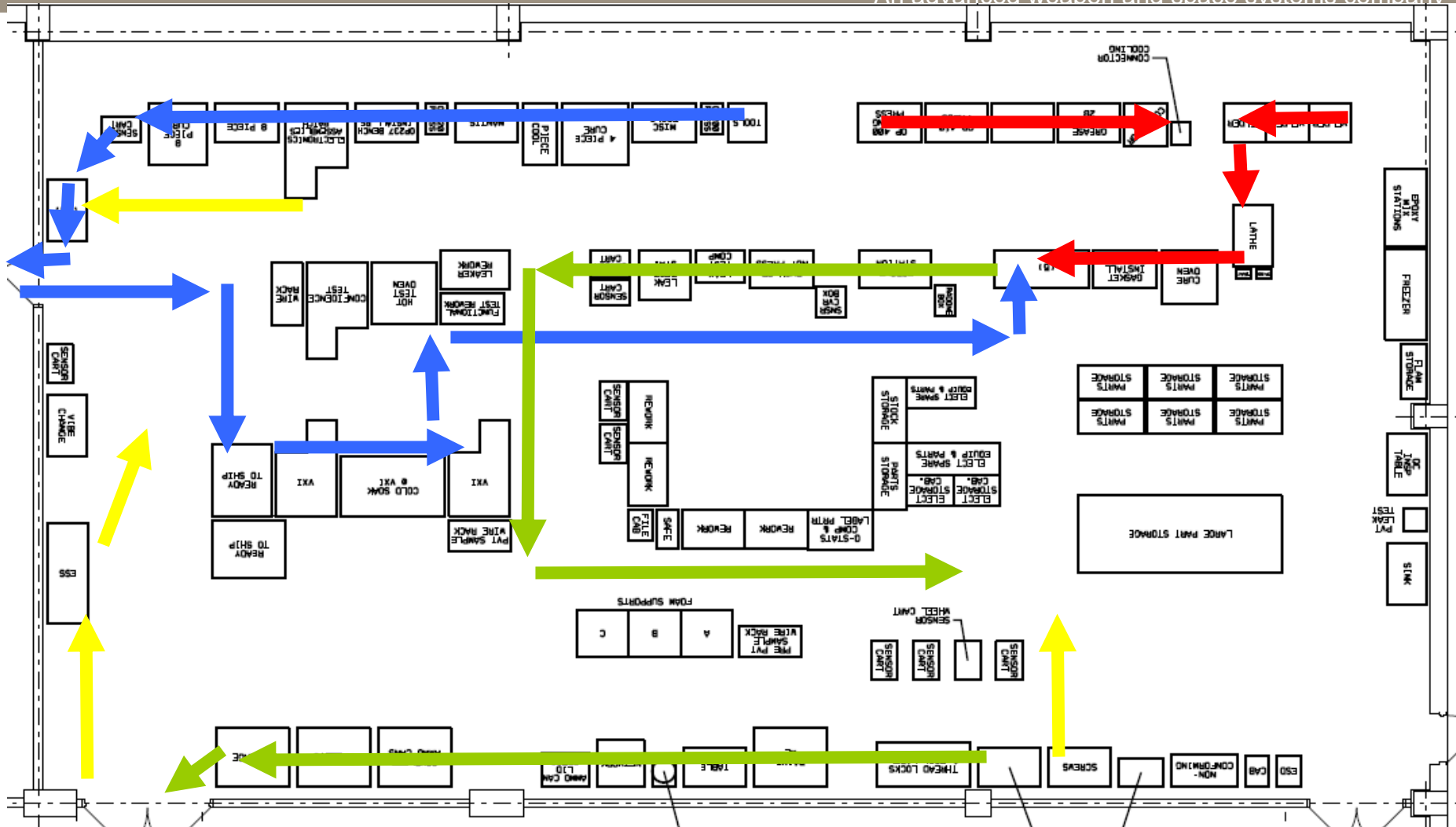
 **SENSOR ASY**

 **MSC MTLs**

# DSU 'Lean'- Future State



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↑ SENSOR TAIL

↑ SENSOR HEAD

↑ SENSOR ASY

↑ MSC MTLs



# QUESTIONS

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